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# **FDMS7556S** N-Channel PowerTrench<sup>®</sup> SyncFET<sup>TM</sup> 25 V, 130 A, 1.2 m $\Omega$

### Features

- Max  $r_{DS(on)}$  = 1.2 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 35 A
- Max  $r_{DS(on)}$  = 1.65 m $\Omega$  at  $V_{GS}$  = 4.5 V,  $I_D$  = 31 A
- Advanced Package and Silicon combination for low r<sub>DS(on)</sub> and high efficiency
- SyncFET Schottky Body Diode
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

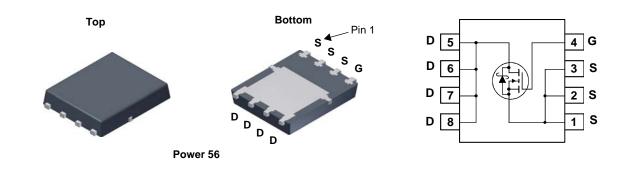


# **General Description**

The FDMS7556S has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest  $r_{DS(on)}$  while maintaining excellent switching performance. This device has the added benefit of an efficient monolithic Schottky body diode.

# Applications

- Synchronous Rectifier for Synchronous Buck Converters
- Notebook
- Server
- Telecom
- High Efficiency DC-DC Switch Mode Power Supplies



## MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			25	V	
V <sub>GS</sub>	Gate to Source Voltage		(Note 4)	±20	V	
I <sub>D</sub>	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25 °C		130		
	-Continuous (Silicon limited) $T_C = 25 \text{ °C}$			222		
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	35	Α	
	-Pulsed			200		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	312	mJ	
<b>D</b>	Power Dissipation	T <sub>C</sub> = 25 °C		96	14/	
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5	W	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature R	ange		-55 to +150	°C	

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.3	°C/W	
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (Note 2	a) 50	C/W	

### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7556S	FDMS7556S	Power 56	13 "	12 mm	3000 units

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 1 mA, V <sub>GS</sub> = 0 V	25			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 10$ mA, referenced to 25 °C		22		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 20 V, V_{GS} = 0 V$			500	μA
GSS	Gate to Source Leakage Current, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
On Chara	cteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 1 \text{ mA}$	1.2	1.6	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{.1}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 10$ mA, referenced to 25 °C		-5		mV/°C
	- •	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 35 A		0.95	1.2	
DS(on)	Static Drain to Source On Resistance	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 31 A		1.3	1.65	mΩ
. ,		$V_{GS}$ = 10 V, $I_{D}$ = 35 A, $T_{J}$ = 125 °C		1.2	1.6	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 35 A		212		S
C <sub>iss</sub> C <sub>oss</sub>	Characteristics Input Capacitance Output Capacitance	V <sub>DS</sub> = 13 V, V <sub>GS</sub> = 0 V, f = 1 MHz		6740 1940	8965 2580	pF pF
C <sub>rss</sub>	Reverse Transfer Capacitance			314	475	pF
R <sub>g</sub>	Gate Resistance			0.6	1.3	Ω
Switching t <sub>d(on)</sub>	<b>Turn-On Delay Time</b>			20	36	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 13 V, I <sub>D</sub> = 35 A,		9	18	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		48	77	ns
f	Fall Time			5.3	11	ns
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		95	133	nC
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V$ $V_{DD} = 13 V$ $I_D = 35 A$		43	60	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	I <sub>D</sub> = 35 A		18.6		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			8.8		nC
Drain-Soເ	urce Diode Characteristics					
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2) $V_{GS} = 0 V, I_S = 35 A$ (Note 2)		0.37 0.74	0.7	V
t <sub>rr</sub>	Reverse Recovery Time			44	71	ns
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>F</sub> = 35 A, di/dt = 300 A/μs		68	109	nC
lotes:	ined with the device mounted on a 1in <sup>2</sup> pad 2 oz copper pad	on a 1.5 x 1.5 in. board of FR-4 material. $R_{AIC}$ is c	uaranteed	by design wh	ile Roon is d	etermined b

1 in<sup>2</sup> pad of 2 oz copper.



b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

2. Pulse Test: Pulse Width < 300  $\mu$ s, Duty cycle < 2.0%.

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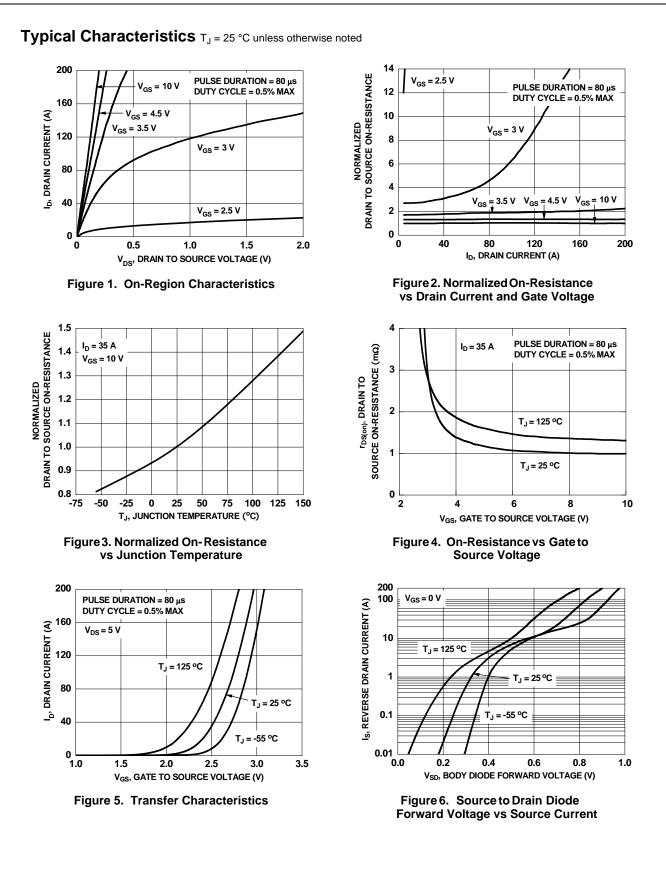
3.  $E_{AS}$  of 312 mJ is based on starting  $T_J$  = 25 °C, L = 1 mH,  $I_{AS}$  = 25 A,  $V_{DD}$  = 23 V,  $V_{GS}$  = 10 V. 100% test at L = 0.3 mH,  $I_{AS}$  = 38 A.

4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

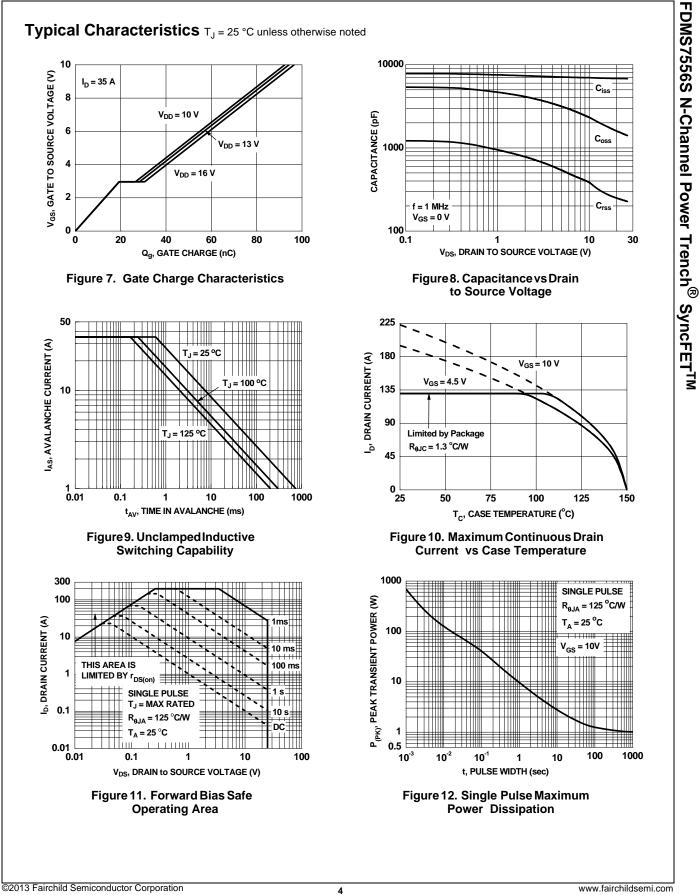
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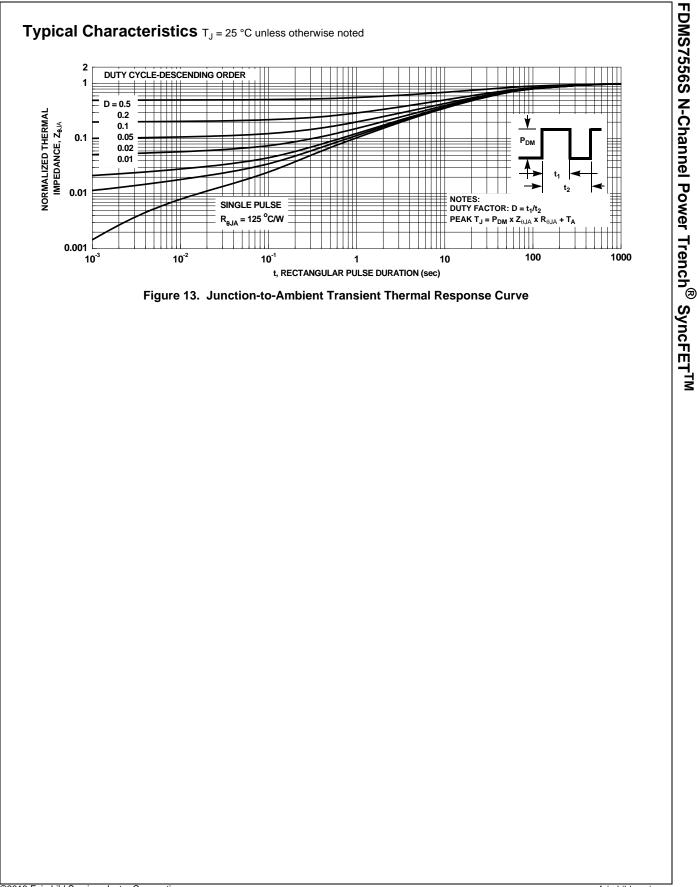
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### Typical Characteristics (continued)

### SyncFET Schottky body diode Characteristics

Fairchild's SyncFET process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverses recovery characteristic of the FDMS7556S.

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

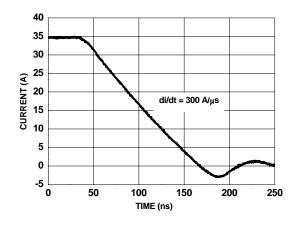


Figure 14. FDMS7556S SyncFET body diode reverse recovery characteristic

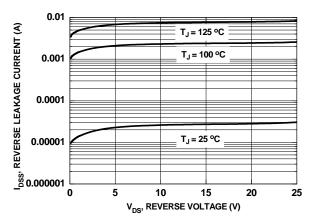
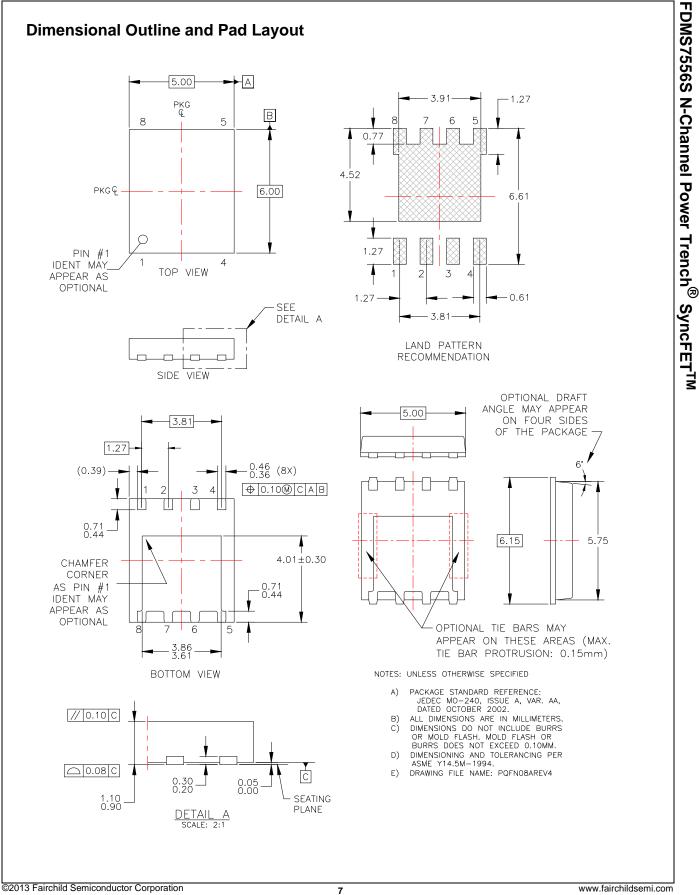


Figure 15. SyncFET body diode reverses leakage versus drain-source voltage



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